



DOCKET NO. 93-C-077C1 (STMI01-93077)
Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: : Loi N. Nguyen, et al.
Serial No. : 09/712,827
Filed : November 14, 2000
For : METHOD AND INTERLEVEL DIELECTRIC
STRUCTURE FOR IMPROVED METAL STEP
COVERAGE
Group No. : 2814
Examiner : L. Pham

Commissioner for Patents

P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

PETITION UNDER 37 C.F.R. § 1.181

Pursuant to 37 C.F.R. § 1.181(a)(3), Applicants respectfully invoke the supervisory authority of the Commissioner with respect to consideration of the references cited by Applicants in an Information Disclosure Statement filed March 27, 2001.

An Information Disclosure Statement was filed by Applicants pursuant to 37 C.F.R. § 1.56 on March 27, 2001. The Information Disclosure Statement was properly filed with a Form PTO-1449 listing all cited references and copies of each reference cited.